High Performance ASIC Cooling Solutions w/Thermal Tape Attachment*

DIGI-KEY PART # ATS1351-ND

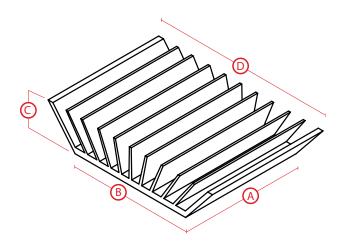
ATS PART # ATS-56006-C4-R0

Features & Benefits

maxiFLOW[™] design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling

Designed specifically for ASIC package and their unique cooling requirements

Thermal Performance Table





| i iici iidi | renormance rable | | | |
|-------------|------------------|--------------------|---------------|--|
| AIR | VELOCITY | THERMAL RESISTANCE | | |
| FT/MIN | M/S | °C/W (UNDUCTED) | °C/W (DUCTED) | |
| 200 | 1.0 | 3.9 | 1.7 | |
| 300 | 1.5 | 3.1 | | |
| 400 | 2.0 | 2.3 | | |
| 500 | 2.5 | 2 | | |
| 600 | 3.0 | 1.7 | | |
| 700 | 3.5 | 1.5 | | |
| 800 | 4.0 | 1.4 | | |
| | | · | | |

Product Details[†]

| DIMENSION A | DIMENSION B | DIMENSION C [§] | DIMENSION D | TIM⁺ | FINISH |
|-------------|-------------|--------------------------|-------------|--------|----------------|
| 50 | 45 | 12 | 59.2 | NO TIM | BLACK-ANODIZED |

For further technical information, please contact Advanced Thermal Solutions, Inc. at **1-781-769-2800** or **www.qats.com**

* RoHS Compliant

‡ TIM = Thermal Interface Material

† Dimensions are measured in millimeters

Dimension C = the height of the heat sink shown above

and does not include the height of the attachment method



